SONY

LCX026AL

2.3cm (0.9-inch) Black-and-White LCD Panel

Description

The LCX026AL is a 2.3cm diagonal active matrix TFT-LCD panel addressed by polycrystalline silicon super thin film transistors with a built-in peripheral driving circuit. Use of three LCX026AL panels provides a full-color representation. The striped arrangement suitable for data projectors is capable of displaying fine text and vertical lines.

The adoption of an advanced on-chip black matrix realizes a high luminance screen. And cross talk free circuit and ghost free circuit contribute to high picture quality.

This panel has a polysilicon TFT high-speed scanner and built-in function to display images up/down and/or right/left inverse. The built-in 5V interface circuit leads to lower voltage of timing and control signals.

The panel contains an active area variable circuit which supports SVGA/VGA/PC98^{*1} data signals by changing the active area according to the type of input signal. In addition, double-speed processed NTSC/PAL can also be supported.

*1 "PC98" is a treadmark of NEC Corporation.

Features

- Number of active dots: 485,000 (0.9-inch, 2.3cm in diagonal)
- Accepts the computer requirements of SVGA (804×604), VGA (644×484) and PC98 (644×404) platforms
- Supports NTSC (644 \times 484) and PAL (762 \times 572) by processing the video signal at double speed
- High optical transmittance: 18% (typ.)
- Built-in cross talk free circuit and ghost free circuit
- High contrast ratio with normally white mode: 350 (typ.)
- Built-in H and V drivers (built-in input level conversion circuit, 5V driving possible)
- Up/down and/or right/left inverse display function
- High durable polarizer used

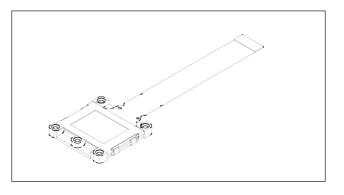
Element Structure

- Dots: 804 (H) × 604 (V) = 485,616
- Built-in peripheral driver using polycrystalline silicon super thin film transistors

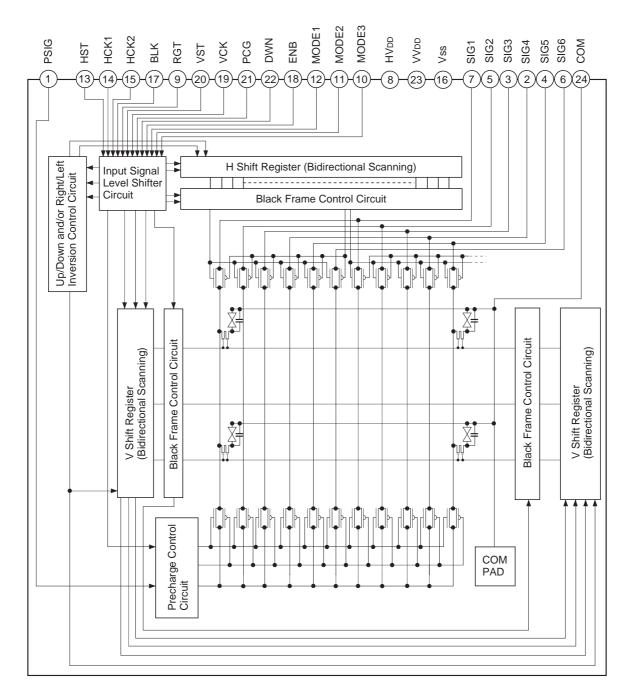
Applications

- Liquid crystal data projectors
- Liquid crystal projectors, etc.

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Block Diagram



Absolute Maximum Ratings (Vss = 0V)

 H driver supply voltage 	HVdd	-1.0 to +20	V
 V driver supply voltage 	VVdd	-1.0 to +20	V
 Common pad voltage 	COM	-1.0 to +17	V
• H shift register input pin voltage	HST, HCK1, HCK2,	-1.0 to +17	V
	RGT		
• V shift register input pin voltage	VST, VCK, PCG,	-1.0 to +17	V
	BLK, ENB, DWN		
	MODE1, MODE2, MODE3		
 Video signal input pin voltage 	SIG1, SIG2, SIG3, SIG4,	-1.0 to +15	V
	SIG5, SIG6, PSIG		
 Operating temperature 	Topr	-10 to +70	°C
 Storage temperature 	Tstg	-30 to +85	°C

Operating Conditions (Vss = 0V)

• Supply voltage

HVDD 15.5 ± 0.5V

VVDD 15.5 ± 0.5V

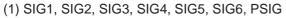
Input pulse voltage (Vp-p of all input pins except video signal and uniformity improvement signal input pins)
 Vin 5.0 ± 0.5V

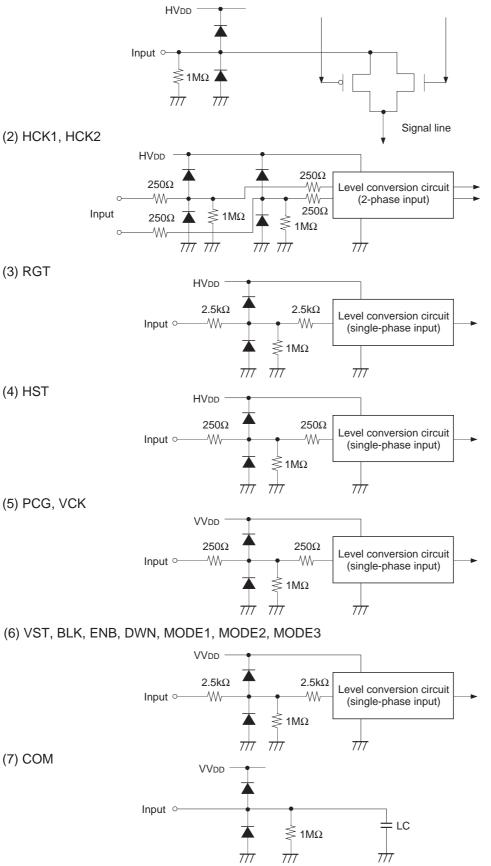
Pin Description

Pin No.	Symbol	Description	Pin No.	Symbol	Description
1	PSIG	Uniformity improvement signal	13	HST	Start pulse for H shift register drive
2	SIG4	Video signal 4 to panel	14	HCK1	Clock pulse for H shift register drive
3	SIG3	Video signal 3 to panel	15	HCK2	Clock pulse for H shift register drive
4	SIG5	Video signal 5 to panel	16	Vss	GND (H, V drivers)
5	SIG2	Video signal 2 to panel	17	BLK	Black Frame display pulse
6	SIG6	Video signal 6 to panel	18	ENB	Enable pulse for gate selection
7	SIG1	Video signal 1 to panel	19	VCK	Clock pulse for V shift register drive
8	HVdd	Power supply for H driver	20	VST	Start pulse for V shift register drive
9	RGT	Drive direction pulse for H shift register (H: normal, L: reverse)	21	PCG	Improvement pulse for uniformity
10	MODE3	Display area switching 3	22	DWN	Drive direction pulse for V shift register (H: normal, L: reverse)
11	MODE2	Display area switching 2	23	VVdd	Power supply for V driver
12	MODE1	Display area switching 1	24	СОМ	Common voltage of panel

Input Equivalent Circuit

To prevent static charges, protective diodes are provided for each pin except the power supplies. In addition, protective resistors are added to all pins except the video signal inputs. All pins are connected to Vss with a high resistor of $1M\Omega$ (typ.). The equivalent circuit of each input pin is shown below: (Resistance value: typ.)





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Input Signals

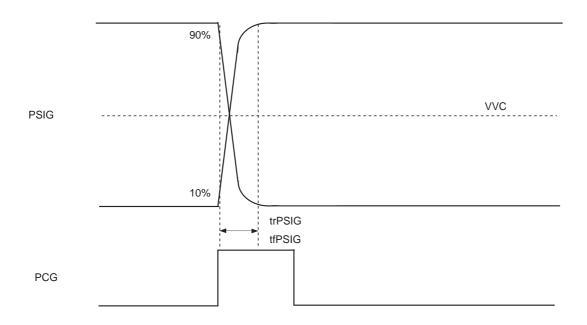
Item		Symbol	Min.	Тур.	Max.	Unit
H shift register input voltage	(Low)	VHIL	-0.5	0.0	0.4	V
HST, HCK1, HCK2, RGT	(High)	VHIH	4.5	5.0	5.5	V
V shift register input voltage MODE1, MODE2, MODE3,	(Low)	VVIL	-0.5	0.0	0.4	V
BLK, VST, VCK, PCG, ENB, DWN	(High)	VVIH	4.5	5.0	5.5	V
Video signal center voltage	1	VVC	6.8	7.0	7.2	V
Video signal input range*1		Vsig	VVC – 4.5	7.0	VVC + 4.5	V
Common voltage of panel*	Common voltage of panel*2		VVC - 0.5	VVC - 0.4	VVC - 0.3	V
Uniformity improvement sig input voltage (PSIG)*3	Inal	Vpsig	VVC ± 4.3	VVC ± 4.5	VVC ± 4.7	V

1. Input signal voltage conditions (Vss = 0V)

*1 Input video signal shall be symmetrical to VVC.

- *2 The typical value of the common pad voltage may lower its suitable voltage according to the set construction to use. In this case, use the voltage of which has maximum contrast as typical value. When the typical value is lowered, the maximum and minimum values may lower.
- *3 Input a uniformity improvement signal PSIG in the same polarity with video signals SIG1 to 6 and which is symmetrical to VVC. Also, the rising and falling of PSIG are synchronized with the rising of PCG pulse, and the rise time trPSIG and fall time tfPSIG are suppressed within 800ns (as shown in a diagram below). The optimum input voltage of PSIG may be changed according as drive conditions of the drive side.

Input waveform of uniformity improvement signal PSIG



Level Conversion Circuit

The LCX026AL has a built-in level conversion circuit in the clock input unit on the panel. The input signal level increases to HV_{DD} or VV_{DD}. The V_{CC} of external ICs are applicable to 5 ± 0.5 V.

	Item	Symbol	Min.	Тур.	Max.	Unit
	Hst rise time	trHst			30	
HST	Hst fall time	tfHst			30	
191	Hst data set-up time	tdHst	50	60	70	
	Hst data hold time	thHst	50	60	70	
	Hckn rise time ^{*4}	trHckn	_	_	30	ns
НСК	Hckn fall time ^{*4}	tfHckn			30	
HUK	Hck1 fall to Hck2 rise time	to1Hck	-15	0	15	
	Hck1 rise to Hck2 fall time	to2Hck	-15	0	15	
	Vst rise time	trVst			100	
VST	Vst fall time	tfVst	—	_	100	
V31	Vst data set-up time	tdVst	5	10	15	– µs
	Vst data hold time	thVst	5	10	15	- μο
VCK	Vck rise time	trVck		_	100	
VCK	Vck fall time	tfVck		_	100	
	Enb rise time	trEnb		_	100	
ENB	Enb fall time	tfEnb		_	100	
EIND	Vck rise/fall to Enb rise time	tdEnb	400	500	600	
	Enb pulse width	twEnb	2400	2500	2600	ns
	Pcg rise time	trPcg		_	30	- 115
PCG	Pcg fall time	tfPcg		_	30	
PCG	Pcg rise to Vck rise/fall time	toVck	900	1000	1100	
	Pcg pulse width	twPcg	1100	1200	1300	
	Blk rise time	trBlk		_	100	
BLK*5	Blk fall time	tfBlk			100	
BLK	Blk fall to Vst rise time	toVst	32	33	34	
	Blk pulse width	twBlk	20	21	22	– µs

2. Clock timing conditions (Ta = 25° C)

(SVGA mode: fHCKn = 4.0MHz, fVCK = 24.0kHz)

*4 Hckn means Hck1 and Hck2.

 $^{*5}\,$ Blk is the timing during SVGA mode (fHckn = 4.0MHz, fVck = 24.0kHz).

<Horizontal Shift Register Driving Waveform>

	Item	Symbol	Waveform	Conditions
	Hst rise time	trHst	Hst 10%	 Hckn^{*3} duty cycle 50% to1Hck = 0ns
	Hst fall time	tfHst	trHst tfHst	to2Hck = 0hs
HST	Hst data set-up time	tdHst	*6 50%	• Hckn ^{*3} duty cycle 50%
	Hst data hold time	thHst	Hck1 50% tdHst thHst	to1Hck = 0ns to2Hck = 0ns
	Hckn rise time ^{*3}	trHckn	90% *3 Hckn 90% 10% 10%	 Hckn^{*3} duty cycle 50%
	Hckn fall time ^{*3}	tfHckn	trHckn tfHckn	to1Hck = 0ns to2Hck = 0ns
нск	Hck1 fall to Hck2 rise time	to1Hck	*6 50%	
	Hck1 rise to Hck2 fall time	to2Hck	Hck2 to2Hck to1Hck	

The left-pointing arrow (-) means -.

The black dot at an arrow (•) indicates the start of measurement.

<Vertical Shift Register Driving Waveform>

	Item	Symbol	Waveform	Conditions
	Vst rise time	trVst	90% 90%	
	Vst fall time	tfVst	Vst 10% trVst tfVst	
VST	Vst data set-up time	tdVst	*6 50% 50% 50% 50%	
	Vst data hold time	thVst	Vck	
VCK	Vck rise time	trVck	90% 90% 10% Vck	
	Vck fall time	tfVck	trVckn tfVckn	
	Enb rise time	trEnb	90% 10% 10% 90%	
	Enb fall time	tfEnb	Enb tfEn trEn	
ENB	Vck rise/fall to Enb rise time	tdEnb	Vck	
	Enb pulse width	twEnb	Enb 50% twEnb tdEnb	
	Pcg rise time	trPcg	Vck 50%	
	Pcg fall time	tfPcg		
PCG*7	Pcg rise to Vck rise/fall time	toVck	50% 50%	
	Pcg pulse width	trPcg	Pcg twPcg	
	Blk rise time	twBlk	Vst / 50%	
	Blk fall time	tfBlk	50%	
BLK	Blk fall to Vst rise time	toVst	Blk 50%	
	Blk pulse width	twBlk	*6 twBlk toVst	

*7 Input the pulse obtained by taking the OR of the above pulse (PCG) and BLK to the PCG input pin.

Electrical Characteristics (Ta = 25°C, HVDD = 15.5V, VVDD = 15.5V)

1. Horizontal drivers

Item		Symbol	Min.	Тур.	Max.	Unit	Condition
Input pin capacitance	HCKn	CHckn		7	12	pF	
	HST	CHst		7	12	pF	
Input pin current	HCK1		-500	-250	_	μA	HCK1 = GND
	HCK2		-1000	-300	_	μA	HCK2 = GND
	HST		-500	-150		μA	HST = GND
	RGT		-150	-30	_	μA	RGT = GND
Video signal input pin ca	apacitance	Csig		130	200	pF	
Current consumption		IH		10.0	15.0	mA	HCKn: HCK1, HCK2 (4.0MHz)

2. Vertical drivers

Item		Symbol	Min.	Тур.	Max.	Unit	Condition
Input pin capacitance	VCK	CVck	_	7	12	pF	
	VST	CVst	_	7	12	pF	
Input pin current	VCK		-1000	-150	—	μA	VCK = GND
PCG, VST, ENB, DWN, BLK, MODE1, MODE2, MODE3			-150	-30	_	μA	PCG, VST, ENB, DWN, BLK, MODE1, MODE2, MODE3 = GND
Current consumption		IV		3.0	6.0	mA	VCK: (24.0kHz)

3. Total power consumption of the panel

Item	Symbol	Min.	Тур.	Max.	Unit
Total power consumption of the panel	PWR		200	300	mW

4. Pin input resistance

Item	Symbol	Min.	Тур.	Max.	Unit
Pin – Vss input resistance	Rpin	0.4	1		MΩ

5. Uniformity improvement signal

Item	Symbol	Min.	Тур.	Max.	Unit
Input pin capacitance for uniformity improvement signal	CPSIGo		8	12	nF

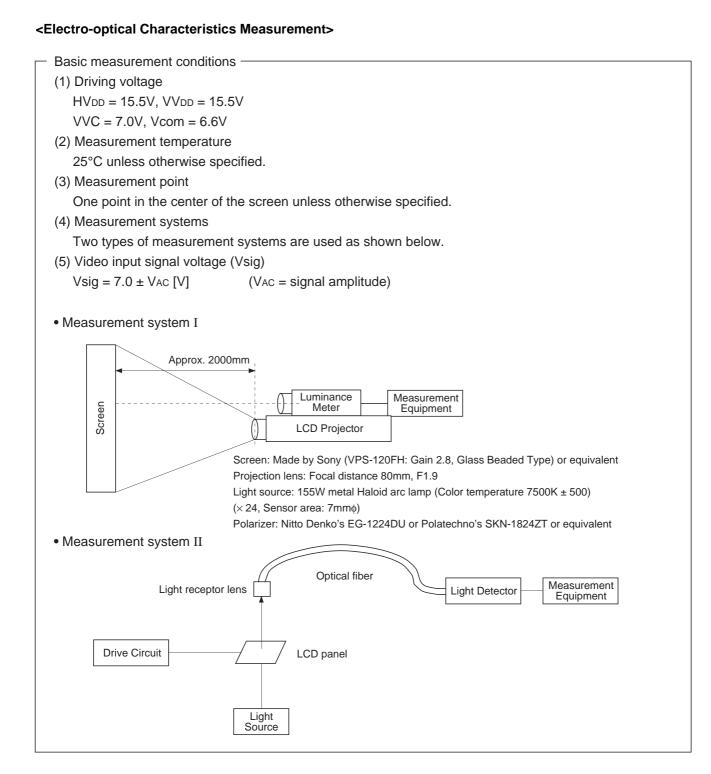
Electro-optical Characteristics

(SVGA mode)

	Item		Symbol	Measurement method	Min.	Тур.	Max.	Unit
Contrast ratio		25°C	CR	1	150	350	_	_
Optical transmitta	ance	25°C	Т	2	15	18	_	%
			RV90-25		1.0	1.3	1.7	
		25°C	GV90-25		1.1	1.5	1.9	
	V90		BV90-25		1.2	1.6	2.0	
	V 90		RV90-60		1.0	1.3	1.6	
		60°C	GV90-60		1.0	1.4	1.7	
			BV90-60		1.1	1.5	1.9	
			RV50-25		1.4	1.7	2.0	
		25°C	GV50-25		1.5	1.8	2.1	
V-T	V50		BV50-25	3	1.6	1.9	2.2	V
characteristics	v 50		RV50-60		1.4	1.6	1.9	
		60°C	GV50-60		1.4	1.7	2.0	
			BV50-60		1.5	1.8	2.1	
		25°C	RV10-25		1.9	2.2	2.5	
			GV10-25		2.0	2.3	2.6	
	V10		BV10-25		2.1	2.4	2.7	
	VIO		RV10-60		1.9	2.1	2.4	
		60°C	GV10-60		1.9	2.2	2.5	
			BV10-60		1.9	2.3	2.6	
	ON time	0°C	ton0		—	30	80	- ms
Response time		25°C	ton25	4	—	12	40	
	OFF time	0°C	toff0	-	—	100	200	
		25°C	toff25			30	70	
Flicker		60°C	F	5	—	-65	-40	dB
Image retention t	ime	25°C	YT60	6			0	S
Cross talk		25°C	СТК	7	_	—	5	%

Reflection Preventive Processing

When a retardation film which rotates the polarization axis is used to adjust to the polarization direction of a polarization screen or prism, use a retardation film with reflection preventive processing on the surface. This prevents characteristic deterioration caused by luminous reflection.



1. Contrast Ratio

Contrast Ratio (CR) is given by the following formula (1).

$$CR = \frac{L \text{ (White)}}{L \text{ (Black)}} \dots (1)$$

L (White): Surface luminance of the center of the screen at the input signal amplitude $V_{AC} = 0.5V$. L (Black): Surface luminance of the center of the screen at $V_{AC} = 4.5V$. Both luminosities are measured by System I.

2. Optical Transmittance

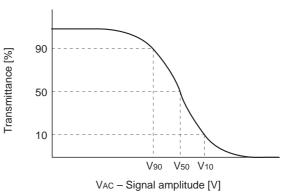
Optical Transmittance (T) is given by the following formula (2).

$$T = \frac{\text{White luminance}}{\text{Luminance of light source}} \times 100 \,[\%] \dots (2)$$

"White luminance" means the maximum luminance on the screen at the input signal amplitude $V_{AC} = 0.5V$ on Measurement System I.

3. V-T Characteristics

V-T characteristics, or the relationship between signal amplitude and the transmittance of the panels, are measured by System II by inputting the same signal amplitude V_{AC} to each input pin. V₉₀, V₅₀, and V₁₀ correspond to the voltages which define 90%, 50%, and 10% of transmittance respectively.



4. Response Time

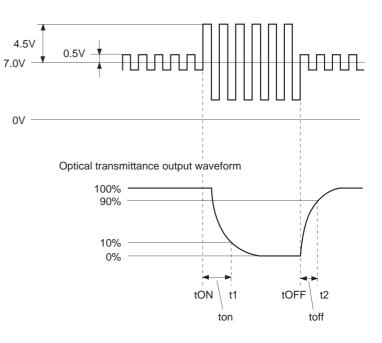
Response time ton and toff are defined by formulas (5) and (6) respectively.

ton = t1 - tON ...(5)

- toff = t2 tOFF ...(6)t1: time which gives 10% transmittance of the panel.
- t2: time which gives 90% transmittance of the panel.

The relationships between t1, t2, tON and tOFF are shown in the right figure.

Input signal voltage (Waveform applied to the measured pixels)



5. Flicker

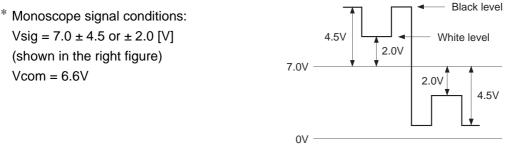
Flicker (F) is given by formula (7). DC and AC (SVGA/VGA/PC98/NTSC: 30Hz, rms, PAL: 25Hz, rms) components of the panel output signal for gray raster^{*} mode are measured by a DC voltmeter and a spectrum analyzer in System II.

$$F [dB] = 20 \log \left\{ \frac{AC \text{ component}}{DC \text{ component}} \right\} ...(7)$$

 * Each input signal voltage for gray raster mode is given by Vsig = 7.0 ± V50 [V] where: V50 is the signal amplitude which gives 50% of transmittance in V-T characteristics.

6. Image Retention Time

Apply the monoscope signal to the LCD panel for 60 minutes and then change this signal to the gray scale of Vsig = $7.0 \pm V_{AC}$ (Vac: 3 to 4V). Judging by sight at the Vac that holds the maximum image retention, measure the time till the residual image becomes indistinct.



Vsig waveform

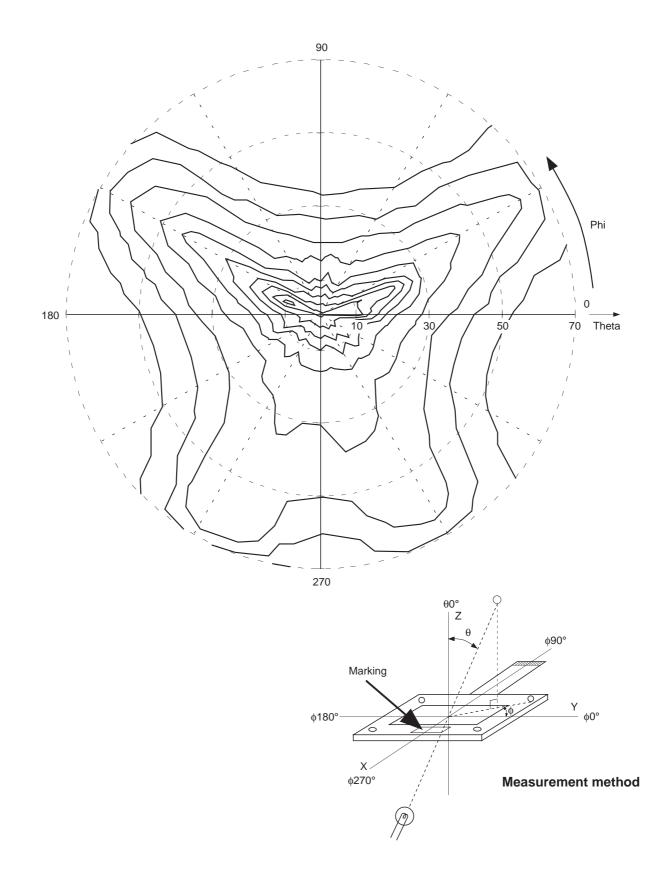
7. Cross Talk

Cross talk is determined by the luminance differences between adjacent areas represented by Wi' and Wi (i = 1 to 4) around a black window (Vsig = 4.5 V/1V).

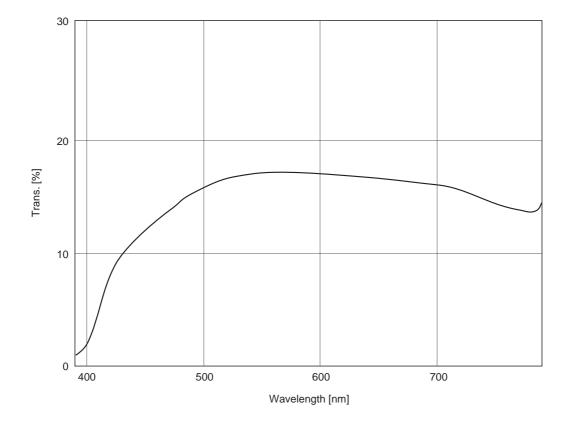
W2 W1	W1'	W4
W2'		W4'
W3	W3'	

Cross talk value CTK =
$$\left|\frac{Wi' - Wi}{Wi}\right| \times 100 \ [\%]$$

Viewing angle characteristics (Typical Value)



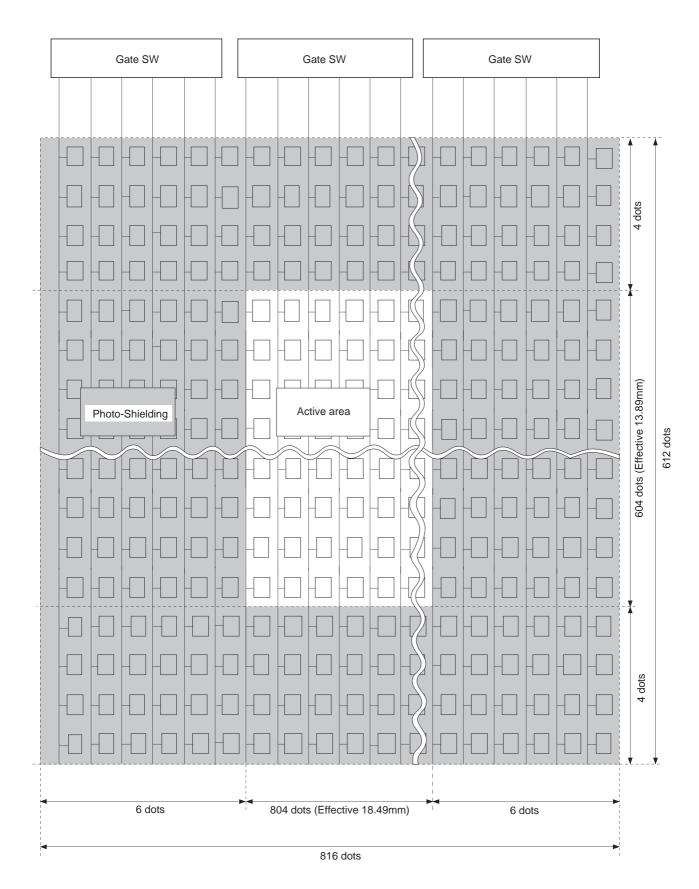
Optical transmittance of LCD panel (Typical Value)



Measurement method: Measurement system II

1. Dot Arrangement

The dots are arranged in a stripe. The shaded area is used for the dark border around the display.



2. LCD Panel Operations

[Description of basic operations]

- A vertical driver, which consists of vertical shift registers, enable-gates and buffers, applies a selected pulse to every 604 gate lines sequentially in a single horizontal scanning period. (in SVGA mode)
- A horizontal driver, which consists of horizontal shift registers, gates and CMOS sample-and-hold circuits, applies selected pulses to every 804 signal electrodes sequentially in a single horizontal scanning period. These pulses are used to supply the sampled video signal to the row signal lines.
- Vertical and horizontal shift registers address one pixel, and then Thin Film Transistors (TFTs; two TFTs) turn on to apply a video signal to the dot. The same procedures lead to the entire 604×804 dots to display a picture in a single vertical scanning period.
- The data and video signals shall be input with the 1H-inverted system.

[Description of operating mode]

This LCD panel can change the active area by displaying a black frame to support various computer or video signals. The active area is switched by MODE1, 2 and 3. However, the center of the screen is not changed. The active area setting modes are shown below.

MODE1	MODE2	MODE3	Display mode
L	L	Н	SVGA 804 × 604
L	н	L	PAL 762 × 572
L	н	Н	VGA/NTSC 644 × 484
н	L	L	PC98 644 × 404

This LCD panel has the following functions to easily apply to various uses, as well as various broadcasting systems.

- Right/left inverse mode
- Up/down inverse mode

These modes are controlled by two signals (RGT and DWN). The right/left and/or up/down setting modes are shown below.

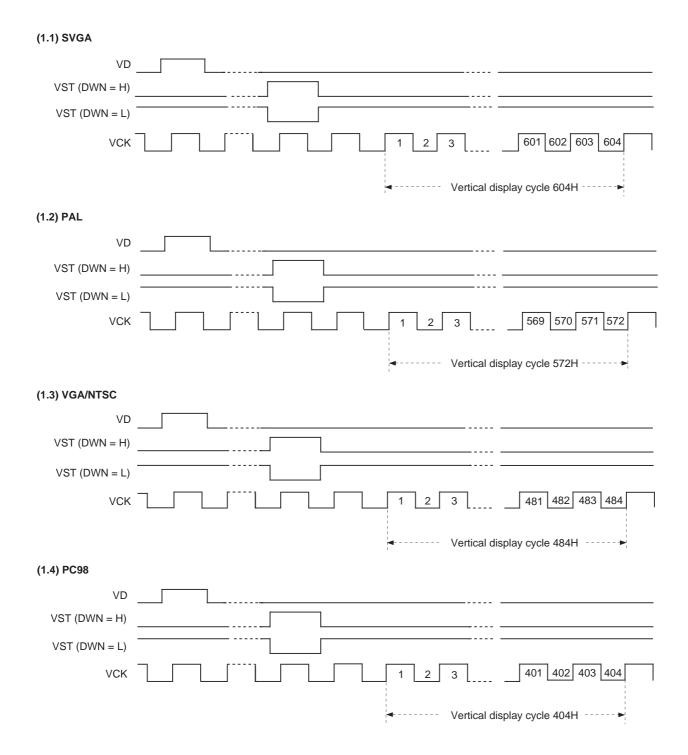
RGT	Mode	
Н	Right scan	
L	Left scan	

DWN	Mode	
н	Down scan	
L	Up scan	

Right/left and/or up/down mean the direction when the Pin 1 marking is located at the right side with the pin block upside.

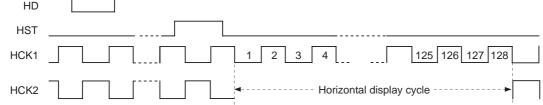
To locate the active area in the center of the panel in each mode, polarity of the start pulse and clock phase for both the H and V systems nust be varied. The phase relationship between the start pulse and the clock for each mode is shown on the following pages.

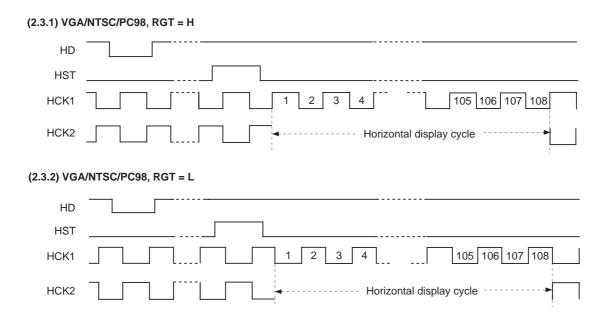
(1) Vertical direction display cycle



(2) Horizontal direction display cycle

(2.1.1) SVGA, RGT = H
HD
HST
HCK1 1 2 3 4 131 132 133 134
HCK2
(2.1.2) SVGA, RGT = L
HD
HST
НСК1 1234 131 132 133 134
HCK2
(2.2.1) PAL, RGT = H
HD
HST
HCK1 1234 125 126 127 128
HCK2
(2.2.2) PAL, RGT = L

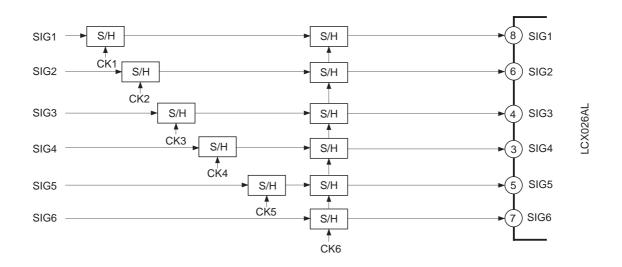




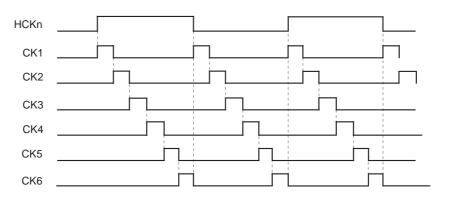
3. 6-dot Simultaneous Sampling

The horizontal shift register samples signals SIG1 to SIG6 simultaneously. This requires phase matching between signals SIG1 to SIG6 to prevent the horizontal resolution from deteriorating. Thus, phase matching between each signal is required using an external signal delaying circuit before applying the video signal to the LCD panel.

The block diagram of the delaying procedure using the sample-and-hold method is as follows. The following phase relationship diagram indicates the phase setting for right scan (RGT = High level). For left scan (RGT = Low level), the phase settings for signals SIG1 to SIG6 are exactly reversed.

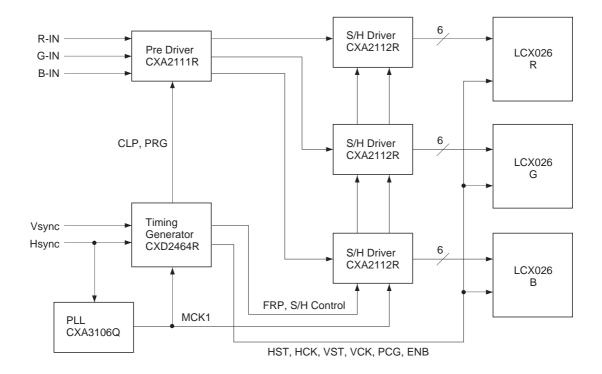


<Phase relationship of delaying sample-and-hold pulses> (right scan)



Display System Block Diagram

An example of display system is shown below.



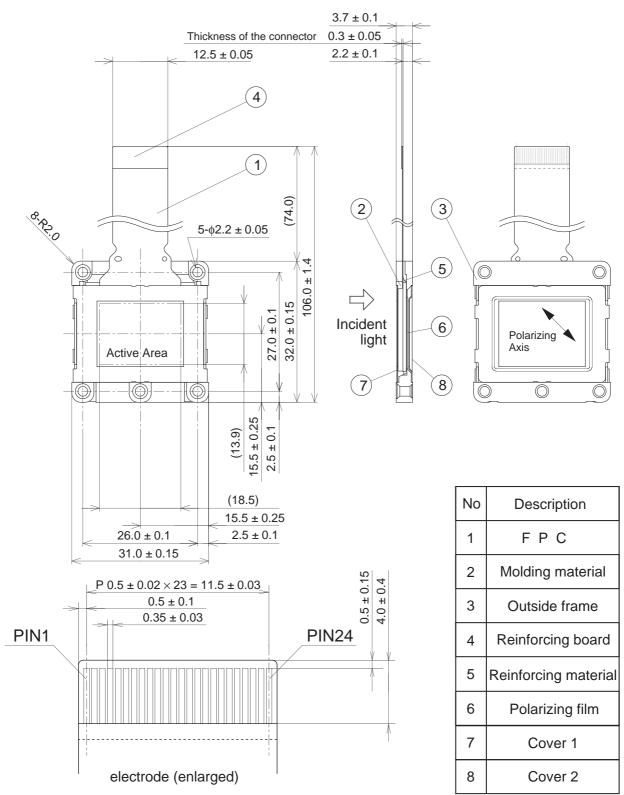
Notes on Handling

(1) Static charge prevention

Be sure to take the following protective measures. TFT-LCD panels are easily damaged by static charges.

- a) Use non-chargeable gloves, or simply use bare hands.
- b) Use an earth-band when handling.
- c) Do not touch any electrodes of a panel.
- d) Wear non-chargeable clothes and conductive shoes.
- e) Install conductive mats on the working floor and working table.
- f) Keep panels away from any charged materials.
- g) Use ionized air to discharge the panels.
- (2) Protection from dust and dirt
 - a) Operate in a clean environment.
 - b) When delivered, the panel surface (Polarizer) is covered by a protective sheet. Peel off the protective sheet carefully so as not to damage the panel.
 - c) Do not touch the panel surface. The surface is easily scratched. When cleaning, use a clean-room wiper with isopropyl alcohol. Be careful not to leave a stain on the surface.
 - d) Use ionized air to blow dust off the panel.
- (3) Other handling precautions
 - a) Do not twist or bend the flexible PC board especially at the connecting region because the board is easily deformed.
 - b) Do not drop the panel.
 - c) Do not twist or bend the panel or panel frame.
 - d) Keep the panel away from heat sources.
 - e) Do not dampen the panel with water or other solvents.
 - f) Avoid storing or using the panel at a high temperature or high humidity, which may result in panel damages.
 - g) Minimum radius of bending curvature for a flexible substrate must be 1mm.
 - h) Torque required to tighten screws on a panel must be $3kg \cdot cm$ or less.

Package Outline Unit: mm



The rotation angle of the active area relative to H and V is $\pm 1^{\circ}$.

weight 5.3g